

## Build-plate temperature optimisation test sheet

Filament:

Printer:

Adhesive:

	$T_0 - 40^\circ\text{C}$	$T_0 - 30^\circ\text{C}$	$T_0 - 20^\circ\text{C}$	$T_0 - 10^\circ\text{C}$	$T_0$	$T_0 + 10^\circ\text{C}$	$T_0 + 20^\circ\text{C}$	$T_0 + 30^\circ\text{C}$	$T_0 + 40^\circ\text{C}$
<b>Build-plate Temperature (<math>^\circ\text{C}</math>)</b>									
<b>Print progress (%)</b>									
<b>Average warp (mm)</b>									

Additional Comments:

Filament:

Printer:

Adhesive:

	$T_0 - 40^\circ\text{C}$	$T_0 - 30^\circ\text{C}$	$T_0 - 20^\circ\text{C}$	$T_0 - 10^\circ\text{C}$	$T_0$	$T_0 + 10^\circ\text{C}$	$T_0 + 20^\circ\text{C}$	$T_0 + 30^\circ\text{C}$	$T_0 + 40^\circ\text{C}$
<b>Build-plate Temperature (<math>^\circ\text{C}</math>)</b>									
<b>Print progress (%)</b>									
<b>Average warp (mm)</b>									

Additional Comments: